

VNP28N04FI VNB28N04/VNV28N04

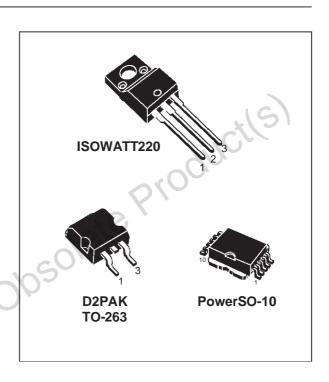
"OMNIFET": FULLY AUTOPROTECTED POWER MOSFET

TYPE	V _{clamp}	R _{DS(on)}	l _{lim}
VNP28N04FI	42 V	$0.035~\Omega$	28 A
VNB28N04	42 V	$0.035~\Omega$	28 A
VNV28N04	42 V	0.035Ω	28 A

- LINEAR CURRENT LIMITATION
- THERMAL SHUT DOWN
- SHORT CIRCUIT PROTECTION
- INTEGRATED CLAMP
- LOW CURRENT DRAWN FROM INPUT PIN
- DIAGNOSTIC FEEDBACK THROUGH INPUT PIN
- ESD PROTECTION
- DIRECT ACCESS TO THE GATE OF THE POWER MOSFET (ANALOG DRIVING)
- COMPATIBLE WITH STANDARD POWER MOSFET



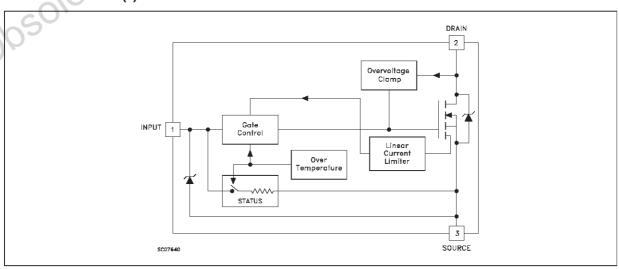
The VNP28N04FI, VNB28N04 and VNV28N04 are monolithic devices made using STMicroelectronics VIPower M0 Technology, intended for replacement of standard power MOSFETS in DC to 50 KHz applications. Built-in thermal shut-down, linear current limitation and overvoltage clamp protect the chip in harsh



enviroments.

Fault feedback can be detected by monitoring the voltage at the input pin.

BLOCK DIAGRAM (*)



(*) PowerSO-10 Pin Configuration: INPUT = 6,7,8,9,10; SOURCE = 1,2,4,5; DRAIN = TAB

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ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Va	lue	Unit
		PowerSO-10 D2PAK	ISOWATT220	
V _{DS}	Drain-source Voltage (V _{in} = 0)	Internally	Clamped	V
Vin	Input Voltage	1	8	V
I _D	Drain Current	Internally	А	
I _R	Reverse DC Output Current	-2	28	Α
Vesd	Electrostatic Discharge (C= 100 pF, R=1.5 KΩ)	20	00	V
P _{tot}	Total Dissipation at T _c = 25 °C	83	34	W
Tj	Operating Junction Temperature	Internally Limited		°C
Tc	Case Operating Temperature	Internally Limited		°C
T _{stg}	Storage Temperature	-55 to	o 150	°C

THERMAL DATA

		ISOWATT220	PowerSO-10	D2PAK	
R _{thj-case}	Thermal Resistance Junction-case Max	3.75	1.5	1.5	°C/W
R _{thj-amb}	Thermal Resistance Junction-ambient Max	62.5	50	62.5	°C/W

ELECTRICAL CHARACTERISTICS (-40 < T_j < 125 $^{\circ}$ C unless otherwise specified) OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
VCLAMP	Drain-source Clamp Voltage	$I_D = 200 \text{ mA}$ $V_{in} = 0$	34	42	51	V
V _{CLTH}	Drain-source Clamp Threshold Voltage	$I_D = 2 \text{ mA}$ $V_{in} = 0$	31			V
VINCL	Input-Source Reverse Clamp Voltage	I _{in} = -1 mA	-1.1		-0.1	V
I _{DSS}	Zero Input Voltage Drain Current (V _{in} = 0)	$V_{DS} = 13 \ V \qquad V_{in} = 0$ $V_{DS} = 25 \ V \qquad V_{in} = 0$			100 200	μA μA
lıss	Supply Current from Input Pin	V _{DS} = 0 V V _{in} = 10 V		250	600	μΑ

ON (*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{IN(th)}	Input Threshold Voltage	$V_{DS} = V_{in}$ $I_D + Ii_n = 1 \text{ mA}$	0.8		3	٧
R _{DS(on)}	Static Drain-source On Resistance	$V_{in} = 10 \text{ V}$ $I_D = 14 \text{ A}$ $V_{in} = 5 \text{ V}$ $I_D = 14 \text{ A}$ $-40 < T_i < 25 \text{ °C}$			0.035 0.05	Ω
		$V_{in} = 10 \text{ V}$ $I_D = 14 \text{ A}$ $V_{in} = 5 \text{ V}$ $I_D = 14 \text{ A}$ $T_j = 125 ^{\circ}\text{C}$			0.07 0.1	Ω

ELECTRICAL CHARACTERISTICS (continued)

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g _{fs} (*)	Forward Transconductance	V _{DS} = 13 V I _D = 14 A	9	18		S
Coss	Output Capacitance	V _{DS} = 13 V f = 1 MHz V _{in} = 0		700	1100	pF

SWITCHING (**)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on Delay Time Rise Time	$V_{DD} = 15 \text{ V}$ $I_{d} = 14 \text{ A}$ $V_{gen} = 10 \text{ V}$ $R_{gen} = 10 \Omega$		100 330	300 800	ns ns
t _{d(off)}	Turn-off Delay Time Fall Time	(see figure 3)		400 155	900 400	ns ns
t _{d(on)} t _r t _{d(off)} t _f	Turn-on Delay Time Rise Time Turn-off Delay Time Fall Time	$\begin{array}{ccc} V_{DD} = 15 \ V & I_d = 14 \ A \\ V_{gen} = 10 \ V & R_{gen} = 1000 \ \Omega \\ (see \ figure \ 3) & & & & & \\ \end{array}$	Pr	450 1.7 7.5 3.4	900 4 25 10	ns µs µs µs
(di/dt) _{on}	Turn-on Current Slope	$V_{DD} = 15 \text{ V}$ $I_{D} = 14 \text{ A}$ $V_{in} = 10 \text{ V}$ $R_{gen} = 10 \Omega$		35		A/μs
Qi	Total Input Charge	$V_{DD} = 12 \text{ V}$ $I_{D} = 10 \text{ A}$ $V_{in} = 10 \text{ V}$		60		nC

SOURCE DRAIN DIODE

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{SD} (*)	Forward On Voltage	$I_{SD} = 14 \text{ A}$ $V_{in} = 0$			2	V
t _{rr} (**)	Reverse Recovery Time	$I_{SD} = 14 \text{ A}$		180		ns
Q _{rr} (**)	Reverse Recovery Charge	(see test circuit, figure 5)		0.45		μC
I _{RRM} (**)	Reverse Recovery Current			7		А

PROTECTION

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{lim}	Drain Current Limit	$V_{in} = 10 \text{ V}$ $V_{DS} = 13 \text{ V}$ $V_{in} = 5 \text{ V}$ $V_{DS} = 13 \text{ V}$	19 19	28 28	41 41	A A
t _{dlim} (**)	Step Response Current Limit	V _{in} = 10 V V _{in} = 5 V		25 70	40 120	μs μs
T _{jsh} (**)	Overtemperature Shutdown		150			°C
T _{jrs} (**)	Overtemperature Reset		135			°C
I _{gf} (**)	Fault Sink Current	$V_{in} = 10 \text{ V}$ $V_{DS} = 13 \text{ V}$ $V_{in} = 5 \text{ V}$ $V_{DS} = 13 \text{ V}$		50 20		mA mA
E _{as} (**)	Single Pulse Avalanche Energy	starting $T_j = 25$ °C $V_{DD} = 20$ V $V_{in} = 10$ V $R_{gen} = 1$ K Ω L = 10 mH	2.5			J

^(*) Pulsed: Pulse duration = 300 μs, duty cycle 1.5 % (**) Parameters guaranteed by design/characterization

PROTECTION FEATURES

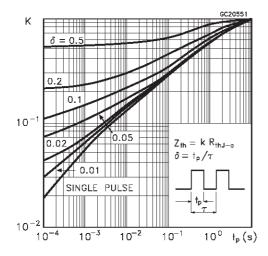
During normal operation, the Input pin is electrically connected to the gate of the internal power MOSFET. The device then behaves like a standard power MOSFET and can be used as a switch from DC to 50 KHz. The only difference from the user's standpoint is that a small DC current (I_{iss}) flows into the Input pin in order to supply the internal circuitry.

The device integrates:

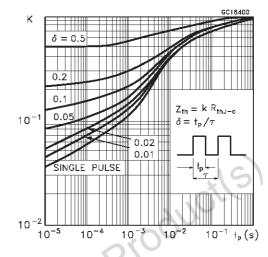
- OVERVOLTAGE CLAMP PROTECTION: internally set at 42V, along with the rugged avalanche characteristics of the Power MOSFET stage give this device unrivalled ruggedness and energy handling capability. This feature is mainly important when driving inductive loads.
- LINEAR CURRENT LIMITER CIRCUIT: limits the drain current ld to llim whatever the Input pin voltage. When the current limiter is active, the device operates in the linear region, so power dissipation may exceed the capability of the heatsink. Both case and junction temperatures increase, and if this phase lasts long enough, junction temperature may reach the overtemperature threshold T_{jsh}.
- OVERTEMPERATURE AND SHORT CIRCUIT PROTECTION: these are based on sensing the chip temperature and are not dependent on the input voltage. The location of the sensing element on the chip in the power stage area ensures fast, accurate detection of the junction temperature. Overtemperature cutout occurs at minimum 150°C. The device is automatically restarted when the chip temperature falls below 135°C.
- STATUS FEEDBACK: In the case of an overtemperature fault condition, a Status Feedback is provided through the Input pin. The internal protection circuit disconnects the input from the gate and connects it instead to ground via an equivalent resistance of 100 Ω . The failure can be detected by monitoring the voltage at the Input pin, which will be close to ground potential.

Additional features of this device are ESD protection according to the Human Body model and the ability to be driven from a TTL Logic circuit (with a small increase in R_{DS(on)}).

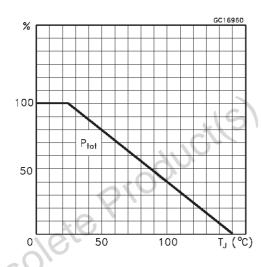
Thermal Impedance For ISOWATT220



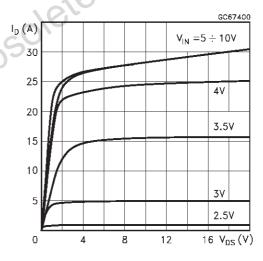
Thermal Impedance For D2PAK / PowerSO-10



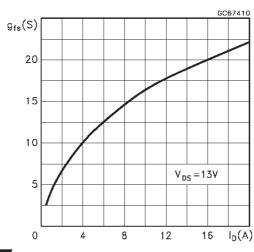
Derating Curve



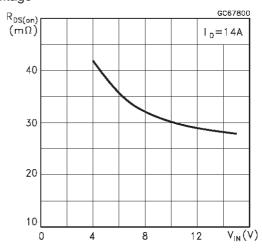
Output Characteristics



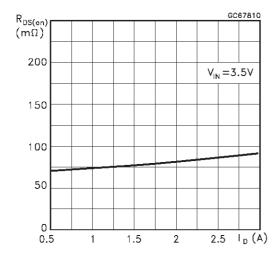
Transconductance



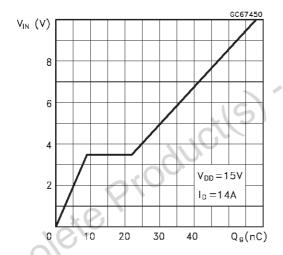
Static Drain-Source On Resistance vs Input Voltage



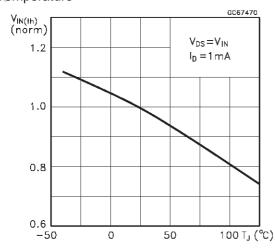
Static Drain-Source On Resistance



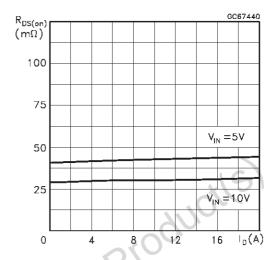
Input Charge vs Input Voltage



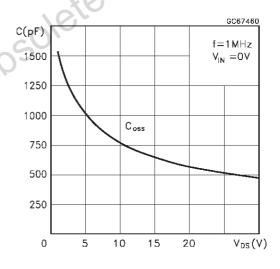
Normalized Input Threshold Voltage vs Temperature



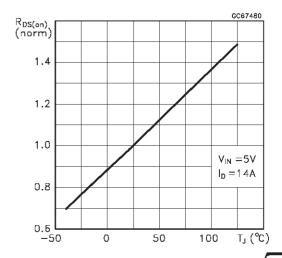
Static Drain-Source On Resistance



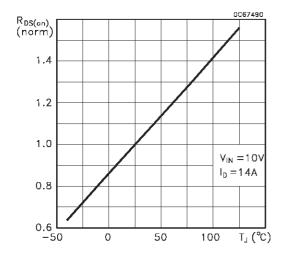
Capacitance Variations



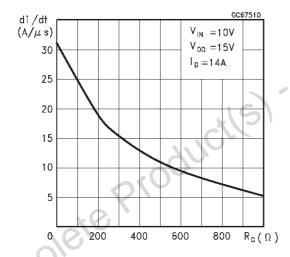
Normalized On Resistance vs Temperature



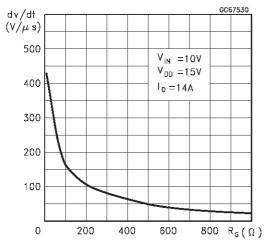
Normalized On Resistance vs Temperature



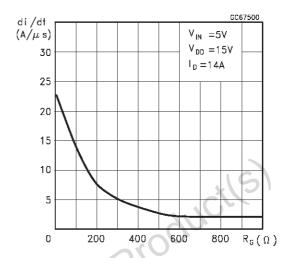
Turn-on Current Slope



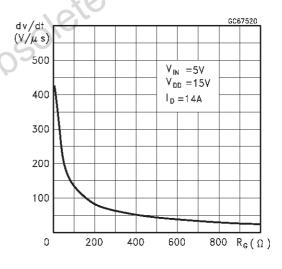
Turn-off Drain-Source Voltage Slope



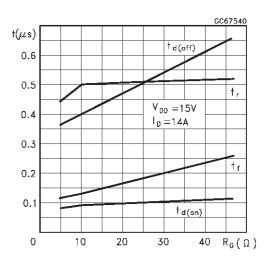
Turn-on Current Slope



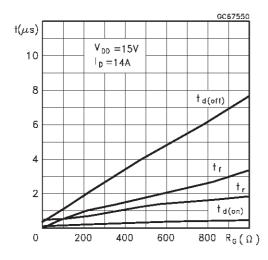
Turn-off Drain-Source Voltage Slope



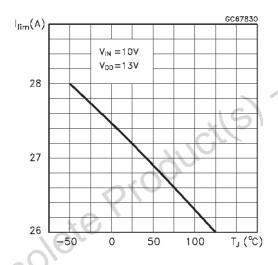
Switching Time Resistive Load



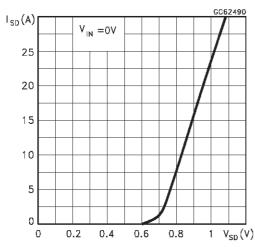
Switching Time Resistive Load



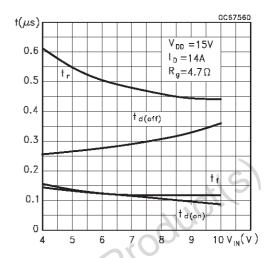
Current Limit vs Junction Temperature



Source Drain Diode Forward Characteristics



Switching Time Resistive Load



Step Response Current Limit

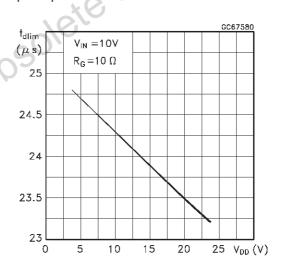


Fig. 1: Unclamped Inductive Load Test Circuits

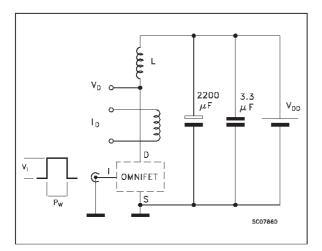


Fig. 3: Switching Times Test Circuits For Resistive Load

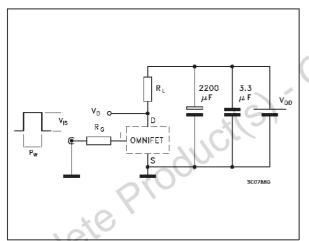


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times

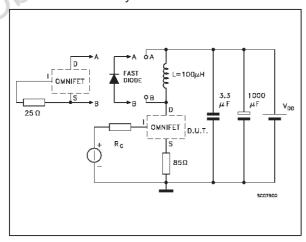


Fig. 2: Unclamped Inductive Waveforms

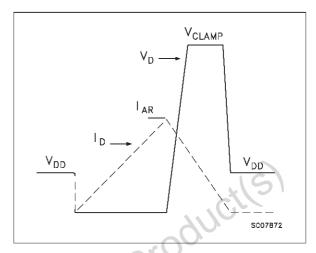


Fig. 4: Input Charge Test Circuit

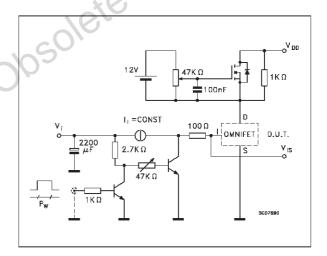
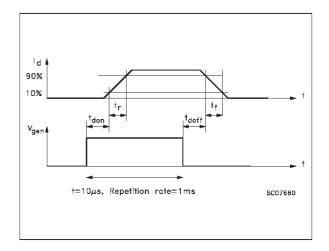
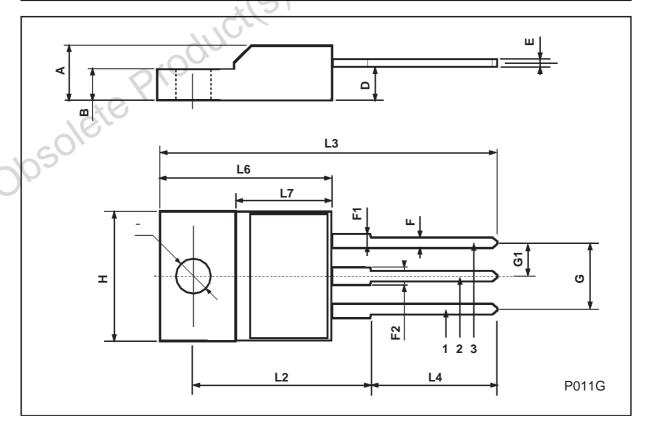


Fig. 6: Waveforms



ISOWATT220 MECHANICAL DATA

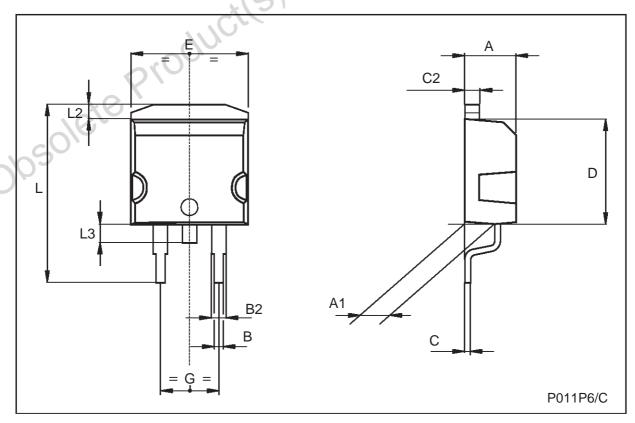
DIM.		mm			inch	
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.4		4.6	0.173		0.181
В	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
E	0.4		0.7	0.015		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195	9/0	0.204
G1	2.4		2.7	0.094	240	0.106
Н	10		10.4	0.393		0.409
L2		16		46	0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	0.385		0.417
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
Ø	3		3.2	0.118		0.126



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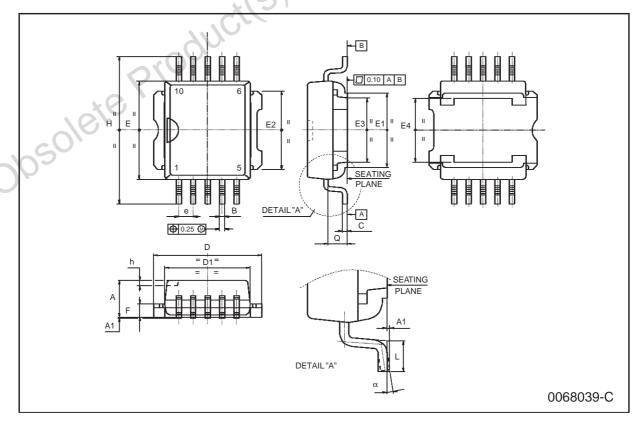
TO-263 (D2PAK) MECHANICAL DATA

DIM.		mm			inch	
Diw.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.3		4.6	0.169		0.181
A1	2.49		2.69	0.098		0.106
В	0.7		0.93	0.027		0.036
B2	1.25		1.4	0.049		0.055
С	0.45		0.6	0.017		0.023
C2	1.21		1.36	0.047	000	0.053
D	8.95		9.35	0.352	2/0	0.368
Е	10		10.28	0.393		0.404
G	4.88		5.28	0.192		0.208
L	15		15.85	0.590		0.624
L2	1.27		1.4	0.050		0.055
L3	1.4	16	1.75	0.055		0.068



PowerSO-10 MECHANICAL DATA

DIM.		mm			inch	
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	3.35		3.65	0.132		0.144
A1	0.00		0.10	0.000		0.004
В	0.40		0.60	0.016		0.024
С	0.35		0.55	0.013		0.022
D	9.40		9.60	0.370		0.378
D1	7.40		7.60	0.291		0.300
Е	9.30		9.50	0.366		0.374
E1	7.20		7.40	0.283		0.291
E2	7.20		7.60	0.283		0.300
E3	6.10		6.35	0.240	240	0.250
E4	5.90		6.10	0.232		0.240
е		1.27		20,	0.050	
F	1.25		1.35	0.049		0.053
Н	13.80		14.40	0.543		0.567
h		0.50			0.002	
L	1.20		1.80	0.047		0.071
q		1.70			0.067	
α	0°	16	8°			



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